



# PCIe® Gen4 NVMe U.2 SSD

The Global Leader in Specialized Storage and Memory Solutions



## Key Features

- 15 mm Fin-Type Heatsink Design
- MCU-based Power Loss Protection Design with Level 4 (data-in-flight) protection\*
- Self-Encrypting Drive (SED) with AES 256-bit Encryption, TCG Opal 2.0\*
- End-to-End Data Path Protection
- Hot-swappable
- pSLC mode support\*
- Anti-sulfuric resistor support\*

\* May vary by product and project support

ATP U.2 SSDs support the NVMe™ protocol on the high-speed PCI Express® (PCIe®) Gen4 x4 interface. Capacities range from 960 GB to 7.68 TB and can either be I-Temp (40°C to 85°C: N651Si) or C-Temp (0°C to 70°C: N601Sc) operable to meet the varied usage requirements of embedded/ industrial PCs, networking systems, and other function-critical segments.

The high-speed PCIe Gen 4 x4 interface offers twice the bandwidth of the previous generation, enabling the N651Si/N601Sc U.2 SSDs to transfer data faster. ATP's PCIe Gen 4 SSDs use x4 lanes for a maximum bandwidth of 8 GB/s.

The 15 mm fin-type heatsink design offers effective heat dissipation to ensure optimal sustained performance.

Technologies & Add-On Services	S.M.A.R.T.	Firmware-based Power Loss Protection	Hardware-based Power Loss Protection	AutoRefresh	Advanced Wear Leveling	Dynamic Data Refresh	End-to-End Data Path Protection	Auto-Read Calibration	Secure Erase	TCG Opal 2.0	Industrial Temperature	Anti-Sulfur Resistors	Conformal Coating	Joint Validation
Superior	○	○	○	○	○	○	○	○	▲	▲	○	▲	▲	▲

▲: Customization option available on a project basis.

## Specifications

PCIe® Gen4 NVMe U.2 SSD	
Product Line	Superior
	N651Si   N601Sc
Interface	PCIe G4 x4
Flash Type	3D TLC
Form Factor	2.5"
Operating Temperature	-40°C to 85°C   0°C to 70°C
Power Loss Protection Options	Hardware + Firmware Based
Optional SED Features	AES 256-bit Encryption, TCG Opal 2.0
Capacity	960 GB to 7.68 TB
Performance	
Sequential Read (MB/s) up to	6,000
Sequential Write (MB/s) up to	5,500
Random Reads IOPS up to	819,000
Random Writes IOPS up to	1,177,000
Endurance and Reliability	
Endurance (TBW) <sup>1</sup> up to	12,300 TB
Reliability MTBF @ 25°C	>2,000,000 hours
Others	
Dimensions (mm)	100 x 69.85 x 15
Certifications	RoHS/VCCI/CE/FCC/UKCA
Warranty	2 years

<sup>1</sup> The actual lifetime of the product will depend on the JESD219A enterprise workload.

Hot Items Ordering Information					
Product Line	Capacity <sub>1</sub>	Operating Temperature <sub>2</sub>	Power Loss Protection <sub>3</sub>	SED <sub>4</sub>	P/N
N601Sc	960GB	-0°C to 70°C	Hardware + Firmware Based	-	AF960GSTKA-HBAXP
N601Sc	1920GB	-0°C to 70°C	Hardware + Firmware Based	-	AF1T92STKA-HBAXP
N601Sc	3840GB	-0°C to 70°C	Hardware + Firmware Based	-	AF3T84STKA-HBAXP
N601Sc	7680GB	-0°C to 70°C	Hardware + Firmware Based	-	AF7T68STKA-HBAXP
N651Si	960GB	-40°C to 85°C	Hardware + Firmware Based	-	AF960GSTKA-HBCIP
N651Si	1920GB	-40°C to 85°C	Hardware + Firmware Based	-	AF1T92STKA-HBCIP
N651Si	3840GB	-40°C to 85°C	Hardware + Firmware Based	-	AF3T84STKA-HBCIP
N651Si	7680GB	-40°C to 85°C	Hardware + Firmware Based	-	AF7T68STKA-HBCIP
N651Si	960GB	-40°C to 85°C	Hardware + Firmware Based	√	AF960GSTKA-HBDIP
N651Si	1920GB	-40°C to 85°C	Hardware + Firmware Based	√	AF1T92STKA-HBDIP
N651Si	3840GB	-40°C to 85°C	Hardware + Firmware Based	√	AF3T84STKA-HBDIP
N651Si	7680GB	-40°C to 85°C	Hardware + Firmware Based	√	AF7T68STKA-HBDIP

<sup>1</sup> Amount of actual usable storage that can be utilized.

<sup>2</sup> Refers to Case Temperature range during device operation, as indicated by SMART temperature attributes.

<sup>3</sup> Hardware + Firmware-based power loss protection design with Level 4 (data-in-flight) protection; Firmware-based power loss protection design with Level 1 (data-at-rest) protection.

<sup>4</sup> Allows data written to and read from the SSD to be constantly and automatically encrypted and decrypted. Conforms to TCG Opal 2.0 and uses AES 256-bit HW encryption.

Product spec and its related information are subject to change without advance notice.

Please refer to [www.atpinc.com](http://www.atpinc.com) for latest information

v1.0 062023

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